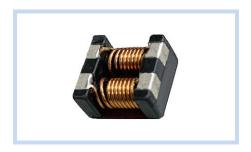
**MERITEK** 

#### **FEATURE**

- Common Mode Filter For Large Current Applications
- Excellent Impedance Characteristics for Noise Suppression
- Low Profile Construction Design
- Application: High-Density Portable Devices, Personal Computers, Display Panels, DC Power Lines and Automotive Power Trains



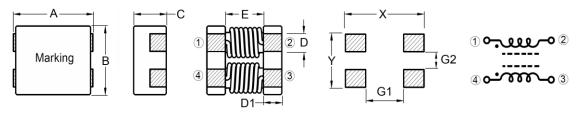


#### **ELECTRICAL CHARACTERISTICS**

Part Number		on Mode ince (Ω)	Test Frequency	DCR Max	Rated Current	Rated Voltage	IR Min
Number	Min	Тур	(MHz)	(mΩ)	(A)	(Vdc)	(MΩ)
SIC80010A12141	80	230	100	2.0	10	125	10
SIC7018A012141	500	700	100	6.0	8.0	125	10
SIC8018A012141	600	800	100	8.0	8.0	125	10
SIC1026A012141	750	1000	100	14	6.0	125	10
SIC2221A812141	2200	2500	100	35	1.8	125	10
SIC2721A512141	2300	2700	100	50	1.5	125	10

Notes:

#### **DIMENSIONS**



Size Code	A ±0.5	B ±0.5	C Max	D	D1	Е Тур	X	Υ	G1	G2
121	12	10.8	6.4	2.7 ±0.2	2.5 ±0.2	7.0	12.2	8.1	6.8	2.3

### **PART NUMBERING SYSTEM**

SIC 272 1A5 121 41 (5)

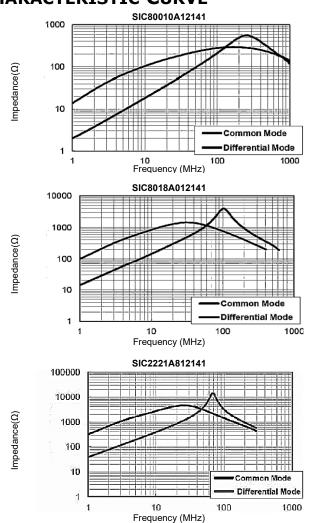
No	Item	Code	Description				
(1)	Product Code	SIC	Surface Mount Inductor, Common Mode Choke type				
(2)	Impedance	272	2700Ω First two digits: significant, Third: M				
(3)	Rated Current	1A5	1.5A	A: Decimal			
(4)	Size Code	121	1.2 X 1.1mm	L x W mm			
(5)	Series Code	41	Common Mode Filter, for Power Line				

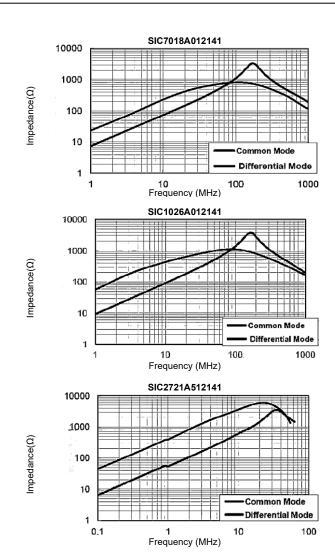
Unit: mm

<sup>1.</sup> All test data referenced to 25°C ambient.

<sup>2.</sup> Operating Temperature: -40°C ~ +125°C (Including Self-temperature rise)

# **CHARACTERISTIC CURVE**



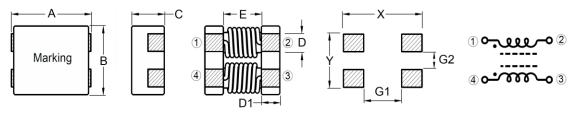


**MERITEK** 

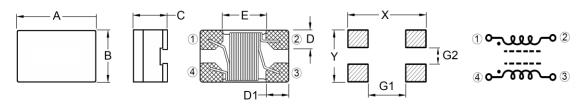
# RELIABILITY TEST CONDITON AND REQUIREMENT

Item		Test Standar	ds / Condition	s / Equipment		Requirement			
Impedance	Agilent-4291A	, Agilent-16197	'A		Refer to specification				
DC Resistance	Agilent-4338B					Refer to specification			
I.R	Agilent-4339				Refer to specification				
Temperature Rise Test	1. Applied the	allowed DC cui e measured by	rent digital surface t	Rated Current < 1A : ΔT = 20°C Max Rated Current ≥ 1A : ΔT = 40°C Max					
Mechanical	Туре	Peak value (g's)	Appearance: No damage Impedance: within ±15% of initial Inductance: within ±10% of initial value						
Shock	SMD	50	11	Half-sine	11.3	Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not			
	Lead	50	11	Half-sine cular axes (18 s	11.3	exceed the specification value			
Solderability	Method B1, 4 Test Time: 5 + Method D cate	Hrs at 155°C d 0/-0.5 seconds	ry heat at 255°0 aging 8 hours±			More than 95% of the terminal electrode should be covered with solder.			
Resistance to Soldering Heat	Temperature r Completely co		ition.	s rate 25mm/s ±6	6 mm/s.	Appearance: No damage Impedance: within ±15% of initial value Inductance: within ±10% of initial value			
Vibration	Total Amplitud	e:1.52mm±10%	K $\sim$ 10 Hz for 20 $^{\prime}_{6}$ inutes, 12 cycle	entations)	Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall no exceed the specification value				
Load Humidity	Humidity: 85±2% R.H. Temperature: 85°C±2°C Duration: 1000Hrs Min at 100% rated current Measured at Room Temperature after 24±2hrs					Appearance: No damage			
Life Test	Temperature: 125±2°C  Life Test  Duration: 1000Hrs Min. with 100% rated current Measured at Room Temperature after 24±2Hrs				Impedance: within ±15% of initial value Inductance: within ±10% of initial value Q: Shall not exceed the specification value				
Thermal Shock	Number of Cy	5minutes, Trans cles: 300cycles	sfer Time: 20sed re after placing			RDC: within ±15% of initial value and shall no exceed the specification value			
Terminal Strength	Component mounted on a PCB apply a force to the side of a device being tested.  >0805inch(2012mm): 1Kg,  <=0805inch(2012mm): 0.5Kg  Duration 60 +1 seconds. The force shall be applied gradually as not to shock the component being tested.					Appearance : No damage			
Board Flex	fixture with the Apply a force v >=0805in(201: <0805in(2012i Duration: 10 s		cing down. the board: orce is to be	Appearance : No damage					
Moisture Resistance	2. Raise tempe 3. Keep at 65° 4. Raise tempe 5. Keep at 65° 6. Keep at 25° 7. Keep at 25°	erature to 65±2 C for 3 hours, cerature to 65±2 C for 3hrs, cool C for 2hrs then C 80-100%RH	°C 90-100%RH cool down to 25 °C 90-100%RH I down to 25°C keep at -10°C f for 15min,Vibra	°C in 2.5hrs. in 2.5hrs in 2.5hrs	ncy of 10 to	Appearance: No damage Impedance: within ±15% of initial value Inductance: within ±10% of initial value Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not exceed the specification value			

#### **DIMENSIONS - SIC-41 Series**



										Unit: mm
Size Code	A ±0.5	B ±0.5	C Max	D	D1	Е Тур	Х	Υ	G1	G2
121	12	10.8	6.4	2.7 ±0.2	2.5 ±0.2	7.0	12.2	8.1	6.8	2.3
70F	7.0	6.00	3.8	1.5 ±0.5	1.7 ±0.5	3.5	9.0	4.5	4.0	1.5
70C	7.0	6.00	3.8	1.5 Typ	1.7 Typ	3.5	9.0	4.5	4.0	1.5
907	9.0	7.00	4.8	1.5 ±0.2	1.7 ±0.2	5.7	11	5.0	5.0	1.5

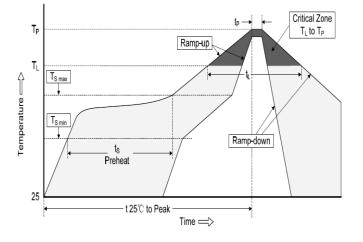


										Unit: mm
Size Code	A ±0.2	B ±0.2	C ±0.2	D ±0.1	D1 ±0.1	Е Тур	Х	Υ	G1	G2
04 (0504)	1.2	1.00	0.9	0.35	0.35	0.5	1.5	1.2	0.6	0.3
03 (0603)	1.6	0.85	1.1	0.30	0.30	1.0	2.3	0.75	0.6	0.25
05 (0805)	2.0	1.20	1.2	0.50	0.50	1.0	2.6	1.25	1.1	0.45
06 (1206)	3.2	1.60	2.0	0.50	0.50	2.2	3.7	1.6	1.9	0.4
10 (1210)	3.2	2.50	2.2	0.80	0.90	1.4	4.4	3.5	1.6	0.6
12 (1812)	4.5	3.20	2.8	1.00	1.20	2.1	4.8	3.8	2.5	0.7

# **RECOMMENDED SOLDERING PROFILES**

Reflow Condition						
	Temp. Min T <sub>s(min)</sub>	150°C				
Pre Heat	Temp. Max T <sub>s(max)</sub>	200°C				
	Time (min. to max.) (t <sub>s</sub> )	60 ~120 seconds				
_	amp up rate (Liquidus ıre) (T <sub>L</sub> ) to peak	3°C/second max				
T <sub>S(max)</sub> to T	∟(Ramp-up rate)	3°C/second max				
Reflow	Temp. (T <sub>L</sub> )	217°C				
Kellow	Time (min. to max.) (t∟)	60 ~150 seconds				
Peak Temp	perature (T <sub>P</sub> )	See table below				
Time withi Temperatu	n 5°C of actual peak ıre (t <sub>p</sub> )	10 seconds max				
Ramp-dov	vn Rate	6°C/second max				
Reflow Tin	nes	3 times max				

Peak Temperature (T <sub>P</sub> )								
Volume < 350mm <sup>3</sup> 350-2000mm <sup>3</sup> > 2000mm <sup>3</sup>								
Thickness < 1.6mm	260°C	260°C	260°C					
Thickness 1.6-2.5mm	260°C	250°C	245°C					
Thickness ≥ 2.5mm	250°C	245°C	245°C					



<sup>\*</sup>Specifications subject to change without notice